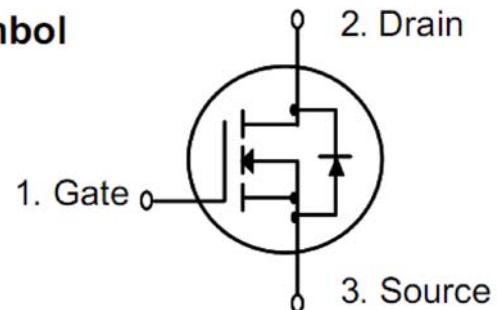


**N-Channel MOSFET****Features**

- $R_{DS(on)}$  (Max 0.95  $\Omega$ )@ $V_{GS}=10V$
- Gate Charge (Typical 25 nC)
- Maximum Junction Temperature Range (150 °C)

**Symbol**

TO-220 AB/3

**Absolute Maximum Ratings**

Symbol	Parameter	Value	Units
$V_{DSS}$	Drain to Source Voltage	400	V
$I_D$	Continuous Drain Current(@ $T_C = 25^\circ C$ )	6.0	A
	Continuous Drain Current(@ $T_C = 100^\circ C$ )	3.6	A
$I_{DM}$	Drain Current Pulsed	24 <sup>..1)</sup>	A
$V_{GS}$	Gate to Source Voltage	$\pm 30$	V
$E_{AS}$	Single Pulsed Avalanche Energy	390 <sup>..2)</sup>	mJ
$E_{AR}$	Repetitive Avalanche Energy	8.75 <sup>..1)</sup>	mJ
$dv/dt$	Peak Diode Recovery $dv/dt$	5.5 <sup>..3)</sup>	V/ns
$P_D$	Total Power Dissipation(@ $T_C = 25^\circ C$ )	87.5	W
	Derating Factor above 25 °C	0.70	W/°C
$T_{STG}$	Operating Junction Temperature	-55 ~ 150	°C
$T_J$	Storage Temperature	150	°C

**Notes**

<sup>1)..</sup> Repeativity rating : pulse width limited by junction temperature

<sup>2)..</sup> L = 19.0 mH,  $I_{AS} = 6.0 A$ ,  $V_{DD} = 50 V$ ,  $R_G = 25 \Omega$  , Starting  $T_J = 25^\circ C$

<sup>3)..</sup>  $I_{SD} \leq 6.0 A$ ,  $di/dt \leq 300 A/\mu s$ ,  $V_{DD} \leq BV_{DSS}$ , Starting  $T_J = 25^\circ C$



### Thermal Characteristics

Symbol	Parameter	Value			Units
		Min.	Typ.	Max.	
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	-	-	1.43	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient*	-	0.5	-	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	-	-	62.5	°C/W

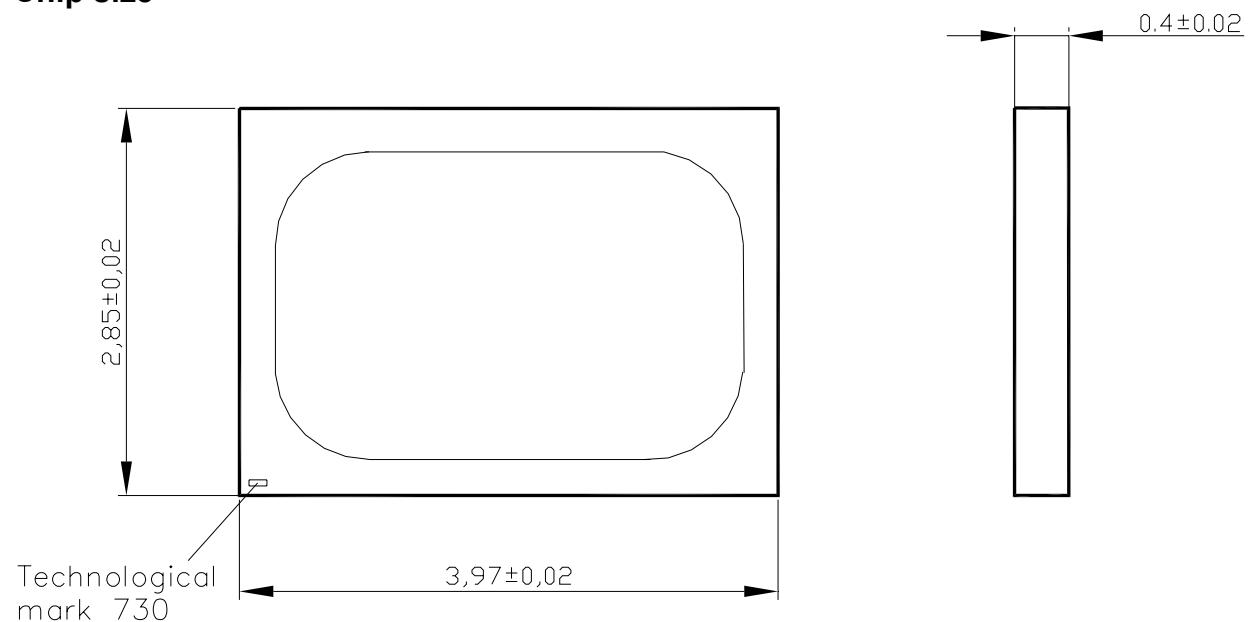
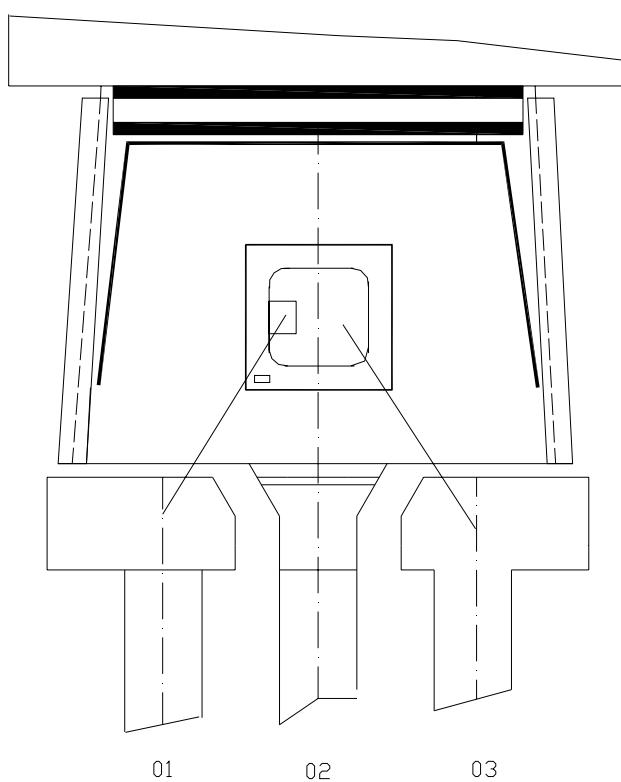
\* When mounted on the minimum pad size recommended (PCB Mount)

### Source-Drain Diode Characteristics and Maximum Ratings

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
$I_S$	Maximum Continuous Source-Drain Diode Forward Current	$I_S = 6.0 \text{ A}, V_{GS} = 0 \text{ V}$	-	-	6.0	A
$I_{SM}$	Maximum Pulsed Source-Drain Diode Forward Current		-	-	24	
$V_{SD}$	Drain-Source Diode Forward Voltage	$I_S = 6.0 \text{ A}, V_{GS} = 0 \text{ V}, dI/dt = 100 \text{ A/us}$	-	-	1.5	V
$t_{rr}$	Reverse Recovery Time		-	220	-	ns
$Q_{rr}$	Reverse Recovery Charge		-	2.0	-	uC

**Electrical Characteristics (  $T_C = 25^\circ\text{C}$  unless otherwise noted )**

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
<b>Off Characteristics</b>						
$\text{BV}_{\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{\text{GS}} = 0 \text{ V}$ , $I_D = 250 \mu\text{A}$	400	-	-	V
$\Delta \text{BV}_{\text{DSS}}/\Delta T_J$	Breakdown Voltage Temperature coefficient	$I_D = 250 \mu\text{A}$ , referenced to $25^\circ\text{C}$	-	0.50	-	$\text{V}/^\circ\text{C}$
$I_{\text{DSS}}$	Drain-Source Leakage Current	$V_{\text{DS}} = 400 \text{ V}$ , $V_{\text{GS}} = 0 \text{ V}$	-	-	10	$\mu\text{A}$
		$V_{\text{DS}} = 320 \text{ V}$ , $T_C = 125^\circ\text{C}$	-	-	100	$\mu\text{A}$
$I_{\text{GSS}}$	Gate-Source Leakage, Forward	$V_{\text{GS}} = 30 \text{ V}$ , $V_{\text{DS}} = 0 \text{ V}$	-	-	100	nA
	Gate-source Leakage, Reverse	$V_{\text{GS}} = -30 \text{ V}$ , $V_{\text{DS}} = 0 \text{ V}$	-	-	-100	nA
<b>On Characteristics</b>						
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{DS}} = V_{\text{GS}}$ , $I_D = 250 \mu\text{A}$	2.0	-	4.0	V
$R_{\text{DS(ON)}}$	Static Drain-Source On-state Resistance	$V_{\text{GS}} = 10 \text{ V}$ , $I_D = 3.0 \text{ A}$	-	0.78	0.95	$\Omega$
<b>Dynamic Characteristics</b>						
$C_{\text{iss}}$	Input Capacitance	$V_{\text{GS}} = 0 \text{ V}$ , $V_{\text{DS}} = 25 \text{ V}$ , $f = 1 \text{ MHz}$	-	670	870	pF
$C_{\text{oss}}$	Output Capacitance		-	95	125	
$C_{\text{rss}}$	Reverse Transfer Capacitance		-	16	21	
<b>Dynamic Characteristics</b>						
$t_{\text{d(on)}}$	Turn-on Delay Time	$V_{\text{DD}} = 200 \text{ V}$ , $I_D = 6.0 \text{ A}$ , $R_G = 25 \Omega$ Pulse Width $\leq 300\text{us}$ , $Q > 50$	-	20	50	ns
$t_r$	Rise Time		-	50	110	
$t_{\text{d(off)}}$	Turn-off Delay Time		-	90	190	
$t_f$	Fall Time		-	55	120	
$Q_g$	Total Gate Charge	$V_{\text{DS}} = 320 \text{ V}$ , $V_{\text{GS}} = 10 \text{ V}$ , $I_D = 6.0 \text{ A}$	-	25	33	nC
$Q_{\text{gs}}$	Gate-Source Charge		-	5	-	
$Q_{\text{gd}}$	Gate-Drain Charge(Miller Charge)		-	10	-	

**Chip size****Package Chip**

## Package Dimensions TO-220 AB/3

